

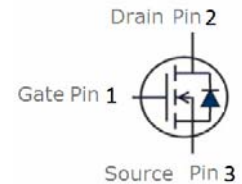
Features

- N-Channel
- Enhancement mode
- Very low on-resistance $R_{DS(on)}$ @ $V_{GS}=4.5V$
- Fast Switching
- 100% Avalanche test
- Pb-free lead plating; RoHS compliant

| | | |
|-------------------------------|-----|------------|
| V_{DS} | 60 | V |
| $R_{DS(on),TYP}@ V_{GS}=10V$ | 5.0 | m Ω |
| $R_{DS(on),TYP}@ V_{GS}=4.5V$ | 6.0 | m Ω |
| I_D | 85 | A |

TO-252


| Part ID | Package Type | Marking | Tape and reel information |
|-------------|--------------|---------|---------------------------|
| VSD007N06MS | TO-252 | 007N06M | 3000pcs/reel |


Maximum ratings, at $T_j=25^\circ\text{C}$, unless otherwise specified

| Symbol | Parameter | Rating | Unit | |
|--|--|------------------------------|------------------|--------------------|
| Common Ratings ($T_c=25^\circ\text{C}$ Unless Otherwise Noted) | | | | |
| V_{GS} | Gate-Source Voltage | ± 20 | V | |
| $V_{(BR)DSS}$ | Drain-Source Breakdown Voltage | 60 | V | |
| T_j | Maximum Junction Temperature | 175 | $^\circ\text{C}$ | |
| T_{STG} | Storage Temperature Range | -55 to 150 | $^\circ\text{C}$ | |
| I_s | Diode Continuous Forward Current | $T_c=25^\circ\text{C}$ 85 | A | |
| Mounted on Large Heat Sink | | | | |
| I_D | Continuous Drain current@ $V_{GS}=10V$ | $T_c=25^\circ\text{C}$ | 85 | A |
| | | $T_c=100^\circ\text{C}$ | 55 | A |
| I_{DM} | Pulse Drain Current Tested ① | $T_c=25^\circ\text{C}$ | 300 | A |
| P_D | Maximum Power Dissipation | $T_c=25^\circ\text{C}$ | 100 | W |
| $R_{\theta JC}$ | Thermal Resistance-Junction to Case | | 1.5 | $^\circ\text{C/W}$ |
| $R_{\theta JA}$ | Thermal Resistance Junction-Ambient | | 52.5 | $^\circ\text{C/W}$ |
| Drain-Source Avalanche Ratings | | | | |
| EAS | Avalanche Energy, Single Pulsed ② | | 93 | mJ |

| Symbol | Parameter | Condition | Min. | Typ. | Max. | Unit |
|---|--|---|------|------|------|------|
| Static Electrical Characteristics @ T_c = 25°C (unless otherwise stated) | | | | | | |
| V _{(BR)DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V I _D =250μA | 60 | -- | -- | V |
| I _{DSS} | Zero Gate Voltage Drain Current(T _c =25°C) | V _{DS} =60V, V _{GS} =0V | -- | -- | 1 | μA |
| | Zero Gate Voltage Drain Current(T _c =125°C) | V _{DS} =60V, V _{GS} =0V | -- | -- | 100 | μA |
| I _{GSS} | Gate-Body Leakage Current | V _{GS} =±20V, V _{DS} =0V | -- | -- | ±100 | nA |
| V _{GS(TH)} | Gate Threshold Voltage | V _{DS} =V _{GS} , I _D =250μA | 1.2 | 1.6 | 2.5 | V |
| R _{DS(ON)} | Drain-Source On-State Resistance ^③ | V _{GS} =10V, I _D =30A | -- | 5.0 | 7.0 | mΩ |
| R _{DS(ON)} | Drain-Source On-State Resistance ^③ | V _{GS} =4.5V, I _D =10A | -- | 6.0 | 9.0 | mΩ |
| Dynamic Electrical Characteristics @ T_c = 25°C (unless otherwise stated) | | | | | | |
| C _{iss} | Input Capacitance | V _{DS} =20V, V _{GS} =0V, f=1MHz | -- | 3485 | -- | pF |
| C _{oss} | Output Capacitance | | -- | 370 | -- | pF |
| C _{rss} | Reverse Transfer Capacitance | | -- | 275 | -- | pF |
| Q _g | Total Gate Charge | V _{DS} =24V, I _D =10A, V _{GS} =10V | -- | 82 | -- | nC |
| Q _{gs} | Gate-Source Charge | | -- | 13 | -- | nC |
| Q _{gd} | Gate-Drain Charge | | -- | 17 | -- | nC |
| Switching Characteristics | | | | | | |
| t _{d(on)} | Turn-on Delay Time | V _{DD} =30V, I _D =5A, R _G =6.8Ω, V _{GS} =10V | -- | 26 | -- | nS |
| t _r | Turn-on Rise Time | | -- | 125 | -- | nS |
| t _{d(off)} | Turn-Off Delay Time | | -- | 58 | -- | nS |
| t _f | Turn-Off Fall Time | | -- | 112 | -- | nS |
| Source- Drain Diode Characteristics @ T_c = 25°C (unless otherwise stated) | | | | | | |
| V _{SD} | Forward on voltage | I _{SD} =30A, V _{GS} =0V | -- | 0.83 | 1.2 | V |
| t _{rr} | Reverse Recovery Time | T _j =25°C, I _{sd} =10A, V _{GS} =0V di/dt=100A/μs | -- | 38 | -- | nS |
| Q _{rr} | Reverse Recovery Charge | | 44 | | | nC |

NOTE:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Limited by T_{jmax}, starting T_J = 25°C, L = 0.3mH, R_G = 25Ω, I_{AS} = 25A, V_{GS} = 10V. Part not recommended for use above this value
- ③ Pulse width ≤ 300μs; duty cycle ≤ 2%.

Typical Characteristics

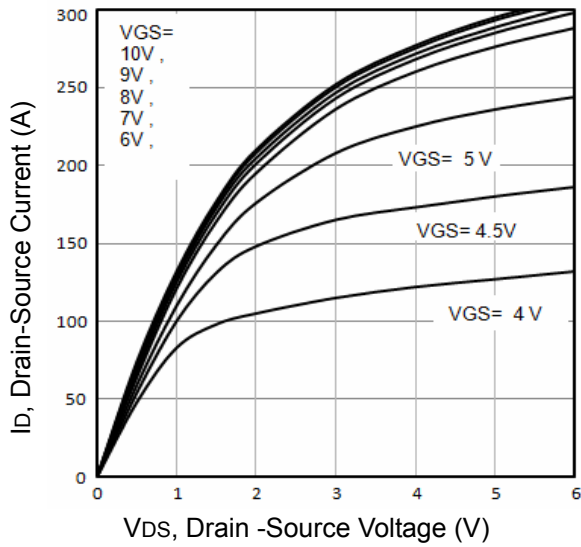


Fig1. Typical Output Characteristics

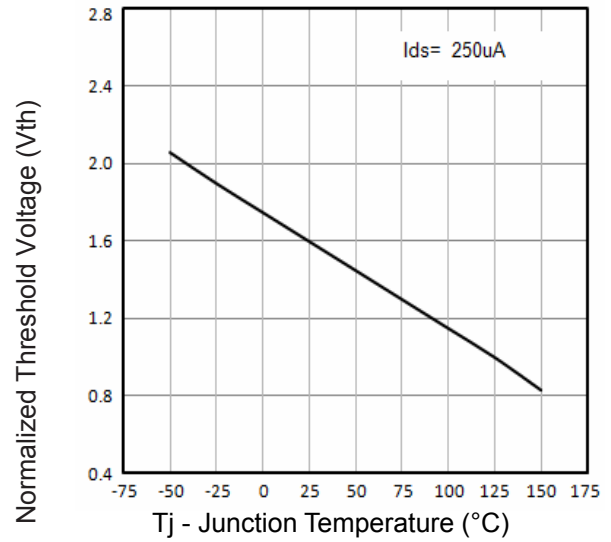


Fig2. Normalized Threshold Voltage Vs. Temperature

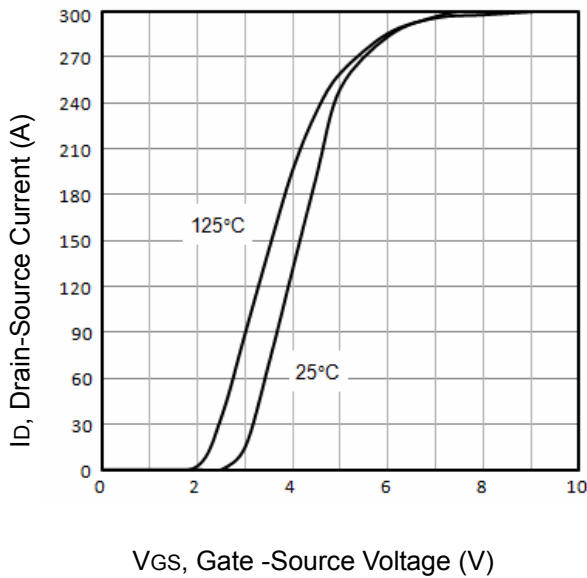


Fig3. Typical Transfer Characteristics

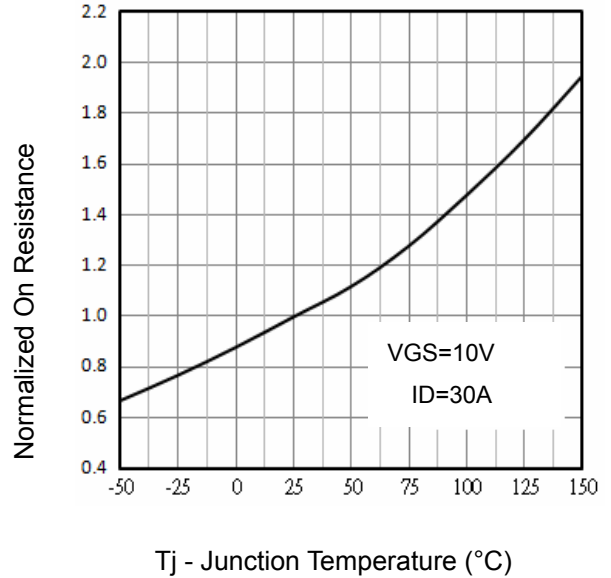


Fig4. Normalized On-Resistance Vs. Temperature

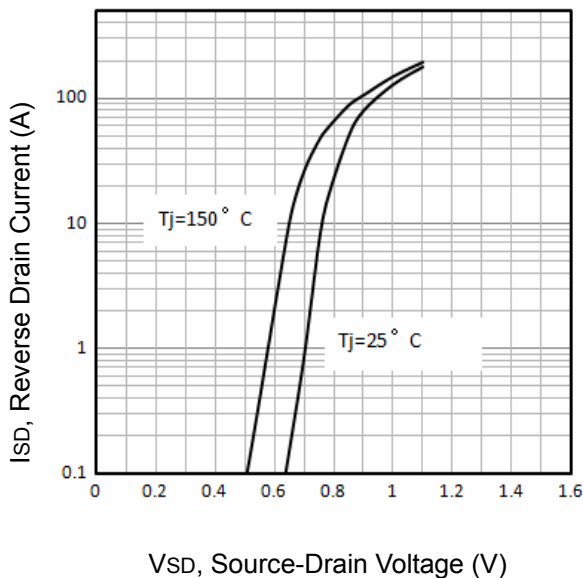


Fig5. Typical Source-Drain Diode Forward Voltage

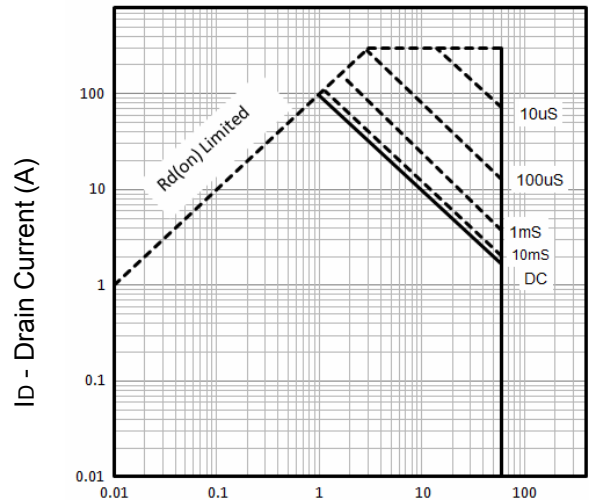
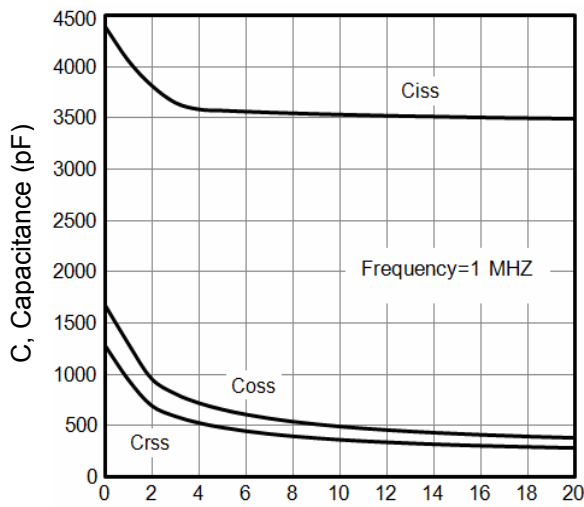


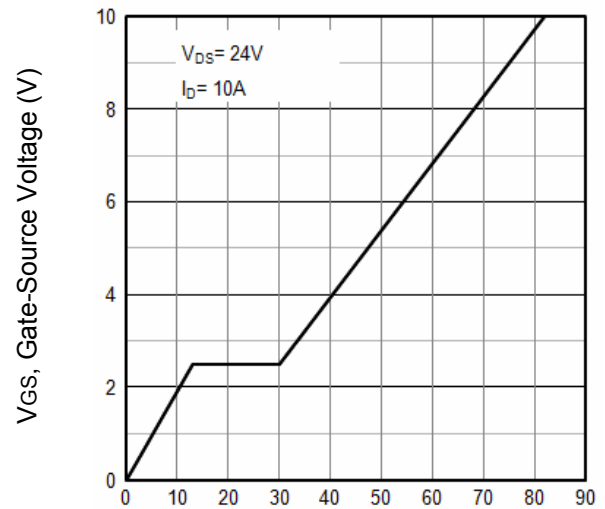
Fig6. Maximum Safe Operating Area

Typical Characteristics



VDS , Drain-Source Voltage (V)

Fig7. Typical Capacitance Vs.Drain-Source Voltage



Qg - Total Gate Charge (nC)

Fig8. Typical Gate Charge Vs.Gate-Source Voltage

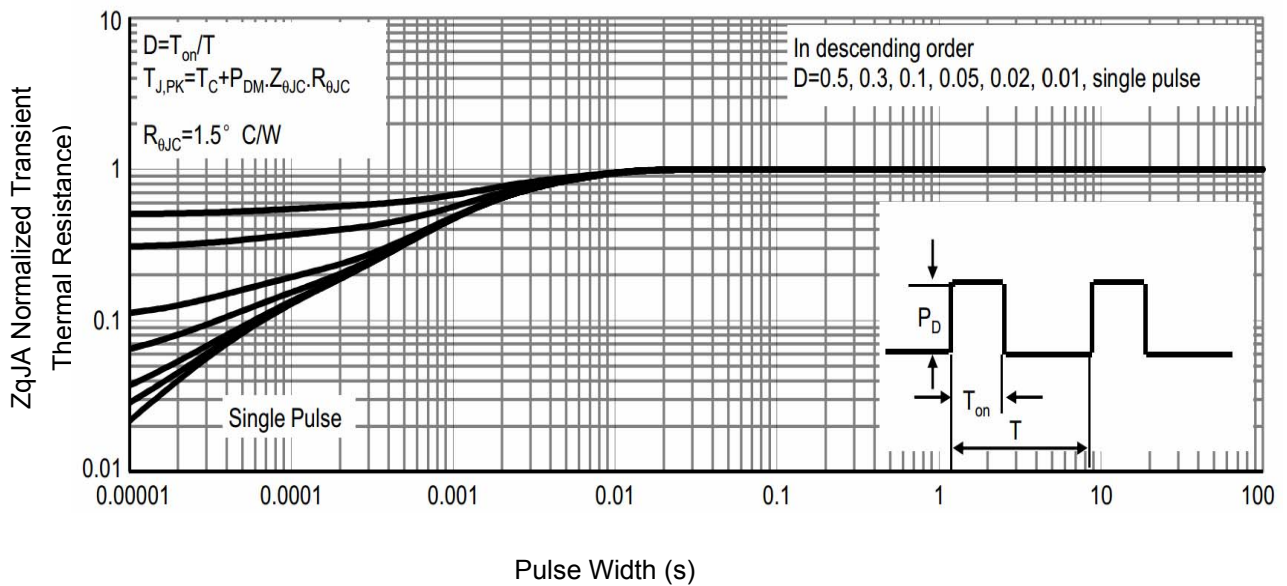


Figure 9: Normalized Maximum Transient Thermal Impedance

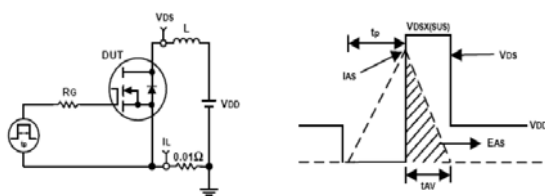


Fig10. Unclamped Inductive Test Circuit and waveforms

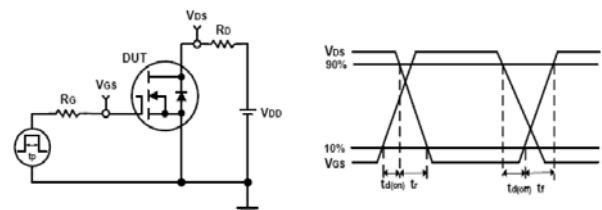
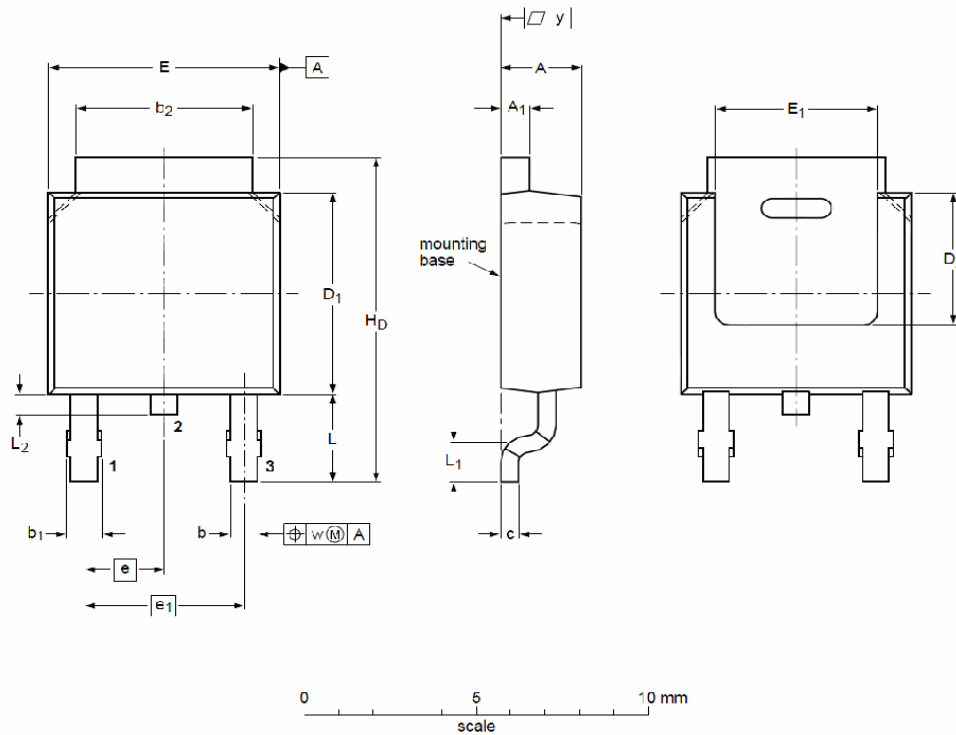


Fig11. Switching Time Test Circuit and waveforms

TO-252 Package Outline



DIMENSIONS (unit : mm)

| Symbol | Min | Typ | Max | Symbol | Min | Typ | Max |
|----------------|------|-------|-------|----------------|------|------|------|
| A | 2.22 | 2.30 | 2.38 | A ₁ | 0.46 | 0.58 | 0.93 |
| b | 0.71 | 0.79 | 0.89 | b ₁ | 0.90 | 0.98 | 1.10 |
| b ₂ | 5.00 | 5.30 | 5.46 | c | 0.20 | 0.40 | 0.56 |
| D ₁ | 5.98 | 6.05 | 6.22 | D ₂ | -- | 4.00 | -- |
| E | 6.47 | 6.60 | 6.73 | E ₁ | 5.10 | 5.28 | 5.45 |
| e | -- | 2.28 | -- | e ₁ | -- | 4.57 | -- |
| H _D | 9.60 | 10.08 | 10.40 | L | 2.75 | 2.95 | 3.05 |
| L ₁ | -- | 0.50 | -- | L ₂ | 0.80 | 0.90 | 1.10 |
| w | -- | 0.20 | -- | y | 0.20 | -- | -- |

Customer Service

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